

PAKCOOL® Two-part Thermally Conductive Silicone Gap Filler TC-235-T

Key Features and Benefits

- 2-parts thermally conductive compound
- Room and accelerated curing schedules
- Ultra-conforming, designed for fragile and lowstress applications
- 100% solids, no cure by products
- Excellent high and low temperature, weather, radiation and exceptional dielectric properties
- Stable chemical and mechanical properties

Description

PAKCOOL® TC-235-T is a high performance, thermally conductive, liquid TIM material, supplied as twopart, room or elevated temperature curing system. It is a soft, form-in-place elastomer, ideal for coupling "hot" electronic components and heat sink. Before cure, it flows under pressure like grease. After cure, it won't be pumped out during thermal cycling. The liquid offers infinite thickness with little or no stress during displacement and assembly. It also eliminates the need for specific pad thickness and diecut shapes for individual applications.

PAKCOOL® TC-235-T consists with liquid A and B. The A component is white, the B component is the colored liquid so as to distinguish A and B are evenly mixed. TC-235-T is intended for use in thermal interface applications when a strong structural bond is not required. TC-235-T is formulated for low-modulus properties.

Applications

- **LED Assembly**
- Power semiconductors/ Power supplies
- **Automotive Battery Packs**
- **Communication devices**
- **Computer and peripherals**
- Area where heat needs to be transferred to a frame, chassis, or other type of heat spreader

Storage Conditions

PAKCOOL® TC-235-T should be storage at low temperatures. Cartridge-based products should be stored horizontally.

Packaging Specifications

Available in 50mL, 200mL and 400mL cartridge kits, and 25Kg, 50Kg pails. Custom packaging options are also available based on customer requirements.

Curing Time

PAKCOOL® TC-235-T can be cure at room temperature for 12h-48h. The crosslinking time will be shortened with the increase of temperature (see table below).

25 °C	24 h
70 °C	60 min

Technical Parameters

Typical Properties	TC-235-T	Test Methods
Base Material	Silicone	
Color	A: White B: Blue	Visual
Mix Ratio	1:1	
Viscosity (cP)	$650,000 \pm 250,000$	ASTM D2196-15
Operation time (min @25 °C)	≥20	
Thermal Conductivity (W/m·K)	3.5	ASTM D5470
Hardness (Shore OO)	50±10	ASTM D2240
Density (g/cm ³)	2.95±0.10	ASTM D792
Volume Resistivity (Ω·cm)	$\geqslant 3.0 \times 10^{13}$	ASTM D257
Dielectric Strength (kV/mm)	≥10	ASTM D149
UL Flammability Rating	V-0	UL 94
Shelf Life (@ < 0°C)	6 months	
Continuous Use Temperature (°C)	- 50 ∼ 150	
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Note: Data is for guidance only and should not be used as product specifications.

Precautions

- This product may not solidify or completely solidify when exposed to some substances, such as sulfur, phosphorus, or nitrogen compounds and polysulfone, polysulfide, polyurethane, substances containing amides and amines, tin, arsenic, antimony, selenium, and tellurium, unsaturated hydrocarbons and plasticizers.
- Due to slight differences in viscosity between parts A and B, adjustments may be necessary to the pressure settings when using machine dispensing for both parts.
- Please store the product in a sealed container. Once mixed, the adhesive should be used in one session to avoid waste.

The data of this specification are obtained under laboratory conditions. However, because of the difference of use environment, process and so on, it can not guarantee the correctness and applicability of the product in some usage and use. When using, be sure to test to confirm the product suitable for your purpose. If you have any problems in using this product, please contact our technical department. We will do our best to help you.